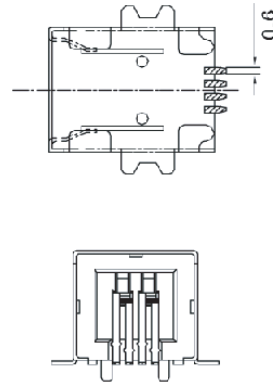


PC Board Layout - Component Side



Specifications

Description AJS09G

USB B
SMT horizontal mount
4 positions

Technical Data AJS09G

Housing: Nylon PA9T G.F.
Contact: Phosphor bronze (t=0.25mm)
Gold/tin plated
Ni:1~1.5u; Tin:3u, Gold:30u
Metal Shell: Brass (t=0.3mm)
Nickel plated
Ni:2~3u
Plating: 30u" gold

Peak reflow temperature time and duration =
260 degree C +/- 5 degree C for 3 +/- 0.5
seconds

Ordering Information

AJS09G	4	4	1	3 - X	0	X
Type	Positions	Contacts	Ports	Plating 3 = 30u"	Insert 1 = Black 2 = White	Packaging 0 = Tray Packing 2 = Tape and Reel

Tolerance
unless otherwise specified

± 0.3

METZ CONNECT	P/N: AJS09G4413-X0X
Desc.: USB B modular jack, USB 2.0 compliant	
Date: 8-27-09 Dimensions in mm	Drawn By: Donna Mears Verified By: Mike Balekdjian

● = Pin 1